

Difference Statement

We, **Cypress Semiconductor** declare our company's product:

Product name: AIROC Bluetooth LE Module

Model name: CYW20829B1-P4CAI100

CYW20829B1-P5CAI100

The differences are as follows:

Model name	Bluetooth chip	Package	Memory Size
CYW20829B1-P4CAI100	CYW20829B1240	BGA64	8Mb available
CYW20829B1-P5CAI100	CYW20829B1340	BGA64	16Mb available

We declare that CYW20829B1-P4CAI100 and CYW20829B1-P5CAI100 have the same PCB, periphery parts and the hardware design of the Bluetooth chip. The only difference between two modules is the available memory size of the Bluetooth chip. The differences between these models do not affect the RF performance and the above mentioned statements of our company are totally true.

Sincerely yours,

Name of authorized signer: Juan Martinez

Title of authorized signer: Senior System Engineer

Date: 2025.07.04

Signature: 